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03/04/02

U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10086875	FILING DATE 03/04/2002	CLASS G38 257	SUBCLASS 101+	GAU 2815	EXAMINER NEMA BERZAY
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**APPLICANTS: Watanabe Masaki; 2813

**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A DIV OF 09/484,024 01/18/2000 PAT 6,355,978

** FOREIGN APPLICATIONS VERIFIED:

JAPAN HEI 11-204930 07/19/1999

PG-PUB DO NOT PUBLISH ☐ RESCIND ☐

Foreign priority claimed ☐ yes ☐ no
35 USC 119 conditions met ☐ yes ☐ no
Verified and Acknowledged Examiners's initials

ATTORNEY DOCKET NO
50090-465

TITLE : Package for accommodating electronic parts, semiconductor device and method for manufacturing package

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

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NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner			
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Shoots Drwg.	Figs. Drwg.
		Print Fig.	
Primary Examiner		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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